SN54ABT16841...WD PACKAGE

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- Members of the Texas Instruments
 Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

These 20-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

SN74ABT16841 . . . DL PACKAGE (TOP VIEW) 56 U 1LE 1OF 55 1D1 1Q1 **1**2 1Q2 43 54 1D2 GND 4 53 | GND 1Q3 **[**]5 52 L 1D3 1Q4 **[**]6 51 1D4 50 | V_{CC} V_{CC} 47 1Q5 🛮 8 49 🛮 1D5 1Q6 49 48 1 1D6 1Q7 4 10 47 **∐** 1D7 GND 🛚 11 46 | GND 1Q8 L 12 45 1D8 1Q9 13 44 L 1D9 43 🛮 1D10 1Q10 L 14 2Q1 L 15 42 2D1 2Q2 L 16 41 2D2 2Q3 [] 17 40 2D3 GND L 18 39 l gnd 19 38 2D4 2Q4 L 37 D 2D5 2Q5 **2**0 36 2D6 21 2Q6 L 35 🛮 V_{CC} 22 V_{CC} 2Q7 🛮 23 34 2D7

24

27

28

2Q8 L

2Q10

2OE

GND 25

2Q9 26

33

∐ 2D8

32 | GND

31 2D9

30 D 2D10

29 | 2LE

The 'ABT16841 can be used as two 10-bit latches or one 20-bit latch. The 20 transparent D-type latches provide true data at the outputs. While the latch-enable (1LE or 2LE) input is high, the Q outputs of the corresponding 10-bit latch follow the D inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable ($1\overline{OE}$ or $2\overline{OE}$) input can be used to place the outputs of the corresponding 10-bit latch in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly.

The output-enable input does not affect the internal operation of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.



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description (continued)

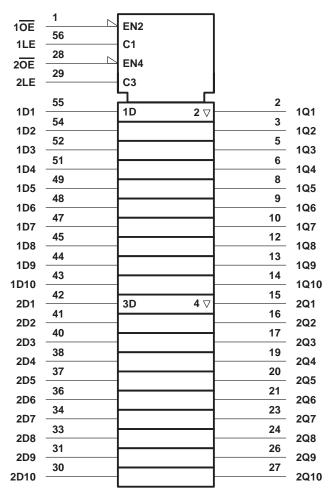
When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16841 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16841 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each 10-bit latch)

	INPUTS		OUTPUT
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q ₀
Н	X	Χ	Z

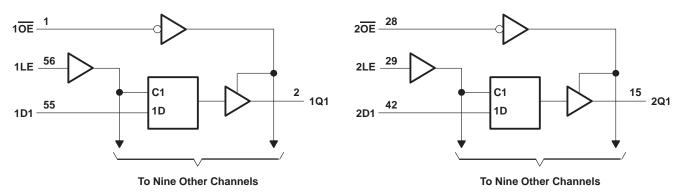
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	-0.5 V to 7 V
Input voltage range, V _I (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V _O	. -0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT16841	96 mA
SN74ABT16841	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): DL package	74°C/W
Storage temperature range, T _{stg}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 3)

			SN54AB	Г16841	SN74AB1	Γ16841	UNIT
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	VCC	0	VCC	V
IOH	High-level output current			-24		-32	mA
loL	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST C	ONDITIONS	Т	A = 25°C	;	SN54AB	Γ16841	SN74AB1	16841	UNIT
PARAMETER	lesi co	CNUTTIONS	MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNII
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.2		-1.2		-1.2	V
	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5		
Vou	$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3			3		3		V
VOH	V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$	2			2				V
	VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2		
VOL	V _{CC} = 4.5 V	I _{OL} = 48 mA			0.55		0.55			V
VOL	VCC = 4.5 V	I _{OL} = 64 mA			0.55*				0.55	V
V _{hys}				100						mV
tı	$V_{CC} = 0 \text{ to } 5.5 \text{ V}$	$V_1 = V_{CC}$ or GND			±1				±1	μΑ
'1	$V_{CC} = 5 \text{ V}, V_{I} = 7$	V _{CC} or GND					±5			μΛ
lozpu [‡]	$V_{CC} = 0 \text{ to } 2.1 \text{ V}$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}$			±50		±50		±50	μА	
IOZPD [‡]	$V_{CC} = 2.1 \text{ V to } 0.000$ $V_{O} = 0.5 \text{ V to } 2.700$			±50		±50		±50	μΑ	
lozh	$V_{CC} = 2.1 \text{ V} \text{ to } 5$ $V_{O} = 2.7 \text{ V}, \overline{\text{OE}} \ge 1$				10		10		10	μΑ
lozL	$V_{CC} = 2.1 \text{ V to } 5$ $V_{O} = 0.5 \text{ V}, \overline{\text{OE}} \ge 0.5 \text{ V}$				-10		-10		-10	μΑ
l _{off}	V _C C = 0,	V_I or $V_O \le 4.5 \text{ V}$			±100				±100	μΑ
I _{CEX} Outputs high	$V_{CC} = 5.5 \text{ V},$	V _O = 5.5 V			50		50		50	μΑ
IO§	$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.5 \text{ V}$	-50	-100	-180	-50	-180	-50	-180	mA
Outputs high	,, ,,,,				0.5		0.5			
I _{CC} Outputs low	$V_{CC} = 5.5 \text{ V, I}_{O}$ $V_{I} = V_{CC} \text{ or GNI}$				89		89		89	mA
Outputs disabled	V = V(() 01 0112				0.5		0.5		0.5	
ΔICC¶	V _{CC} = 5.5 V, On Other inputs at V			1.5		1.5		1.5	mA	
C _i	V _I = 2.5 V or 0.5	V		3.5						pF
Co	V _O = 2.5 V or 0.5	5 V		7.5						pF

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		SN54A	3T16841	
		V _{CC} = 5 V, T _A = 25°C	MIN MAX	UNIT
		MIN MAX	1	
t _W	Pulse duration, LE high or low	4	4	ns
t _{su}	Setup time, data before LE↓	3	3	ns
th	Hold time, data after LE↓	2.6	2.6	ns



[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] This parameter is characterized, but not production tested.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[¶] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		9	N74AB	T16841		
		V _{CC} = T _A = 2	5 V, 25°C	MIN	MAX	UNIT
		MIN MAX				
t _W	Pulse duration, LE high or low	4		4		ns
t _{su}	Setup time, data before LE↓	1		1		ns
th	Hold time, data after LE↓	2		2		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

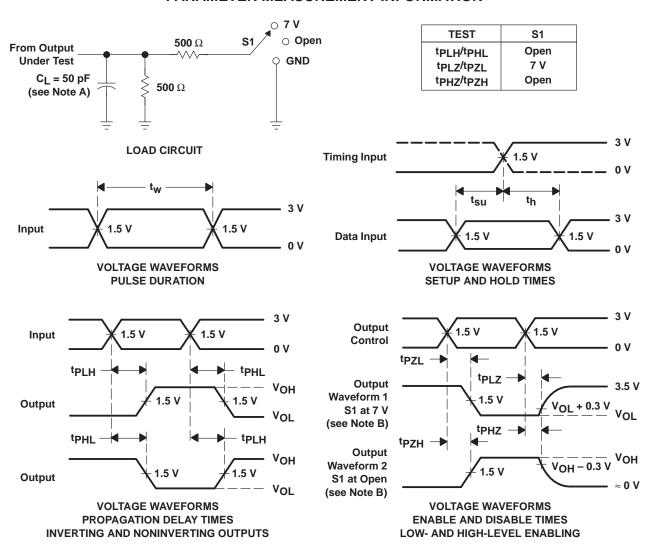
				SN54ABT16841						
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V A = 25°C	/, ;	MIN	MAX	UNIT		
				TYP	MAX					
t _{PLH}	D	Q	1.1	3.2	4.3	1.1	5.7	ns		
^t PHL	В	3	1.6	3.5	4.5	1.6	5.3	113		
t _{PLH}	LE	Q	1.1	3.2	4.4	1.1	5.6	ns		
t _{PHL}	LL	3	1.6	3.4	5	1.6	5.5	115		
^t PZH	ŌĒ	Q		3.2	4.7	1.2	5.8	ns		
tPZL	OE	y	1.7	3.6	5	1.7	5.7	115		
^t PHZ	ŌĒ	Q	2.2	4.1	6.6	2.2	7.7	ns		
^t PLZ	OE .	ζ	1.9	4.4	5.8	1.2	8.4	115		

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

				SN7	4ABT16	841		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V 4 = 25°C	/, ;	MIN	MAX	UNIT
				TYP	MAX			
t _{PLH}	D	Q	1.1	3.2	4.3	1.1	5	ns
t _{PHL}	D	Q	1.6	3.5	4.5	1.6	5.1	115
t _{PLH}	LE	Q	1.1	3.2	4.4	1.1	5	ns
t _{PHL}	LL	l q	1.6	3.4	4.6	1.6	5	115
^t PZH	ŌĒ	Q	1.2	3.2	4.7	1.2	5.7	ns
t _{PZL}	OE .	Q	1.7	3.6	5	1.7	5.6	115
t _{PHZ}	ŌĒ	OF Q		4.1	5.7	2.2	6.5	ne
tPLZ) OE		1.9	4.4	5.8	1.9	7.1	ns

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50 \Omega$, $t_{f} \leq 2.5 \text{ ns.}$
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

10-Dec-2020

PACKAGING INFORMATION

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ABT16841DL	ACTIVE	SSOP	DL	56	20	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16841	Samples
SN74ABT16841DLR	ACTIVE	SSOP	DL	56	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16841	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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10-Dec-2020

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16841DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN74ABT16841DLR	SSOP	DL	56	1000	367.0	367.0	55.0	

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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